Unit: mm

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type ($L^2-\pi$ -MOSV)

2SK2376

Chopper Regulator, DC–DC Converter and Motor Drive Applications

- 4 V gate drive
- Low drain-source ON resistance $: R_{DS}(ON) = 13 \text{ m}\Omega \text{ (typ.)}$
- High forward transfer admittance $: |Y_{fs}| = 40 \text{ S} (typ.)$
- Low leakage current $: I_{DSS} = 100 \ \mu A \ (max) \ (V_{DS} = 60 \ V)$
- Enhancement-mode : $V_{th} = 0.8 \sim 2.0 V (V_{DS} = 10 V, I_D = 1 mA)$

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V _{DSS}	60	V	
Drain-gate voltage (R _{GS} = 20 kΩ)		V _{DGR}	60	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	۱ _D	45	А	
	Pulse (Note 1)	I _{DP}	180	А	
Drain power dissipatio	n (Tc = 25°C)	PD	100	W	
Single pulse avalanch	e energy (Note 2)	E _{AS}	701	mJ	
Avalanche current		I _{AR}	45	А	
Repetitive avalanche e	energy (Note 3)	E _{AR}	10	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	

Thermal Characteristics

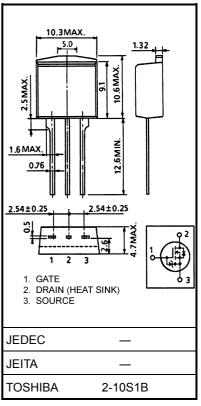
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	1.25	°C / W
Thermal resistance, channel to ambient	R _{th (ch−a)}	83.3	°C / W

Note 1: Please use devices on condition that the channel temperature is below 150°C.

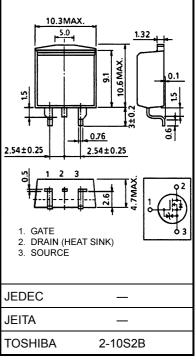
Note 2: V_DD = 25 V, T_ch = 25 °C (initial), L = 471 $\mu H, R_G$ = 25 Ω, I_{AR} = 45 A

Note 3: Repetitive rating; Pulse width limited by maximum channel temperature.

This transistor is an electrostatic sensitive device. Please handle with caution.



Weight: 1.5 g (typ.)



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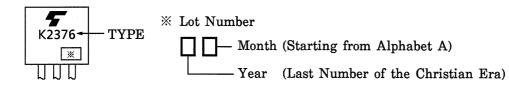
Electrical Characteristics (Ta = 25°C)

Charao	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V_{GS} = ±16 V, V_{DS} = 0 V	_	_	±10	μA
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V	_	_	100	μA
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	60	_	_	V
Gate threshold	voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	0.8	_	2.0	V
			V _{GS} = 4 V, I _D = 25 A	_	19	25	
Drain-source ON resistance	R _{DS (ON)}	V _{GS} = 10 V, I _D = 25 A	_	13	17	mΩ	
Forward transfe	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 25 A	28	40	_	S
Input capacitance	ce	C _{iss}			3350	_	pF
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		550	_	
Output capacitance		Coss			1600	_	
Switching time	Rise time	tr	$V_{GS} \stackrel{10V}{}_{0V} \prod_{\substack{OU} \\ C \\ $	_	25	_	
	Turn-on time	t _{on}		_	55	_	ns
	Fall time	t _f		—	60	_	115
	Turn-off time	t _{off}	$VDD \Rightarrow 30V$ Duty $\leq 1\%$, t _w =10 μ s	_	180	_	
Total gate charge (Gate-source plus gate-drain) Qg		Qg		_	110	_	
Gate-source charge		Q _{gs}	V _{DD} ≈ 48 V, V _{GS} = 10 V, I _D = 45 A		70	—	nC
Gate-drain ("miller") charge		Q _{gd}			40	_	

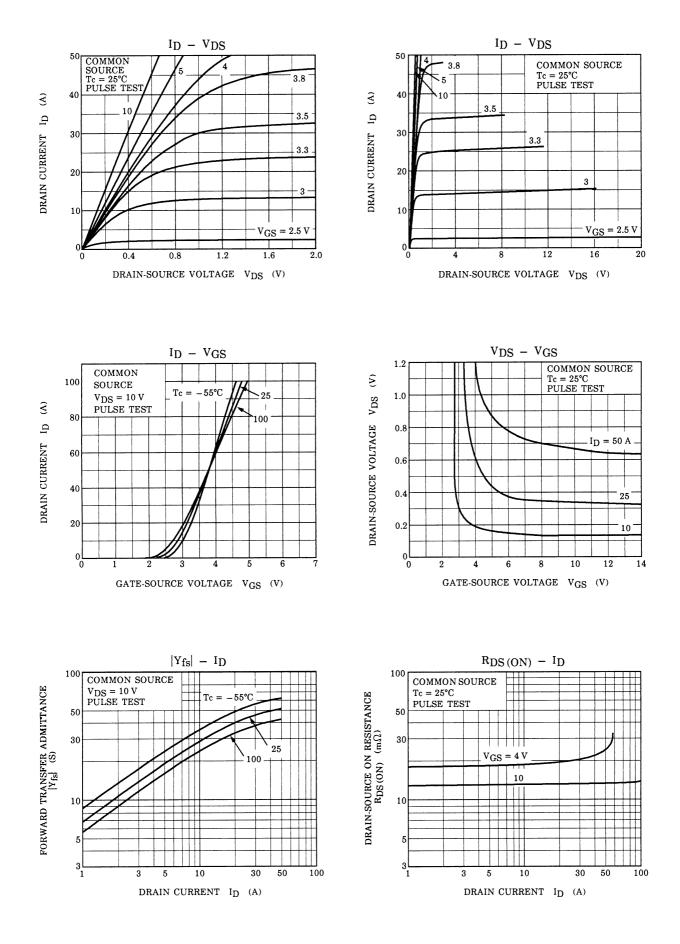
Source–Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	45	А
Pulse drain reverse current (Note 1)	I _{DRP}	—	_	_	180	A
Forward voltage (diode)	V _{DSF}	I _{DR} = 45 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 45 A, V _{GS} = 0 V		120		ns
Reverse recovery charge	Qrr	dI _{DR} / dt = 50 A / μs		0.2		μC

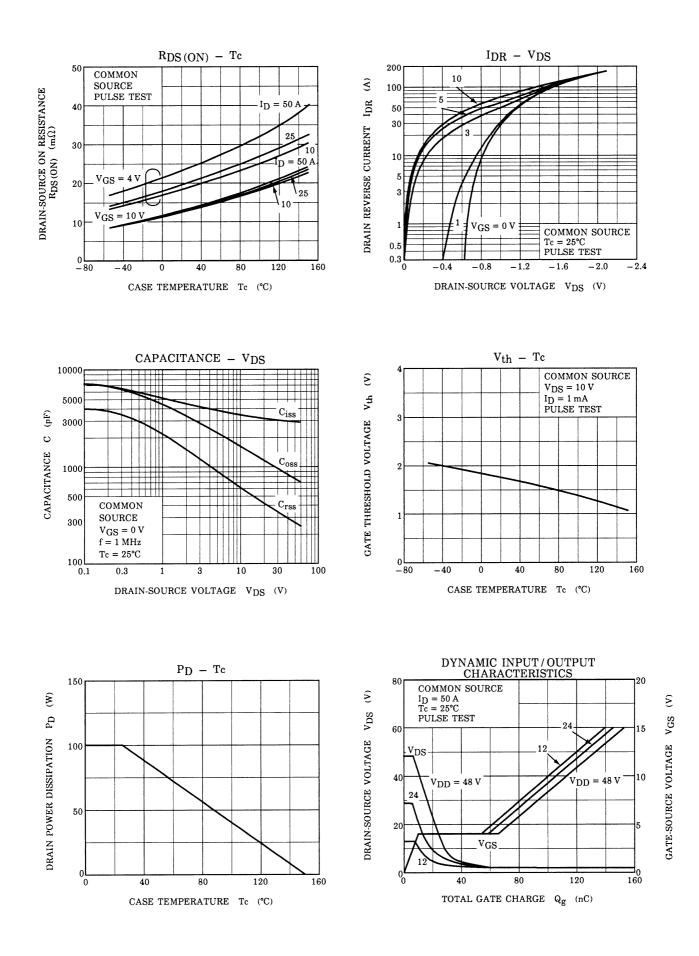
Marking



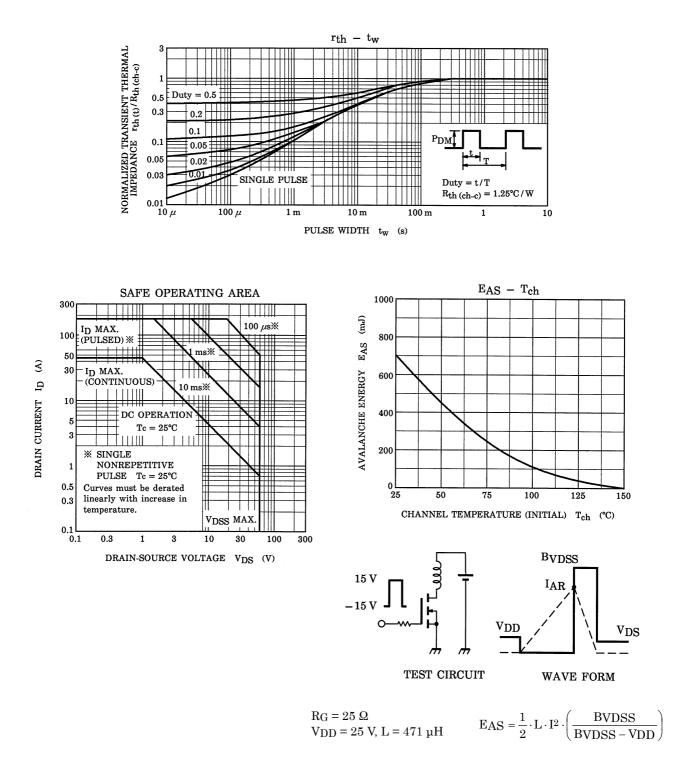
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